

1814728

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Printed circuit board terminal, nominal current: 6 A, rated voltage (III/2): 160 V, nominal cross section: 0.5 mm², number of potentials: 4, number of rows: 1, number of positions per row: 4, product range: PTSM 0,5/..-V-SMD WH, pitch: 2.5 mm, connection method: Push-in spring connection, mounting: SMD soldering, conductor/PCB connection direction: 90 °, color: signal white, Pin layout: Linear pad geometry, number of solder pins per potential: 1, type of packaging: 44 mm wide tape

Your advantages

- · White design: Stable color when welding and during use
- · Time saving push-in connection, tools not required
- · Defined contact force ensures that contact remains stable over the long term
- · High current carrying capacity of 6 A in very compact dimensions
- · Designed for integration into the SMT soldering process
- · Vertical connection enables multi-row arrangement on the PCB
- · Additional solder anchors reduce the mechanical strain on the soldering spots

Commercial data

Item number	1814728
Packing unit	400 pc
Minimum order quantity	400 pc
Sales key	AA11
Product key	AAKDAD
GTIN	4046356760478
Weight per piece (including packing)	2.431 g
Weight per piece (excluding packing)	2.4 g
Customs tariff number	85369010
Country of origin	IN



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Technical data

Product properties

Product type	Printed circuit board terminal
Product family	PTSM 0,5/V-SMD WH
Product line	COMBICON Terminals XS
Number of positions	4
Pitch	2.5 mm
Number of connections	4
Number of rows	1
Number of potentials	4
Pin layout	Linear pad geometry
Solder pins per potential	1

Electrical properties

Properties

roperios	
Nominal current I _N	6 A
Nominal voltage U _N	160 V
Rated voltage (III/3)	63 V
Rated surge voltage (III/3)	2.5 kV
Rated voltage (III/2)	160 V
Rated surge voltage (III/2)	2.5 kV
Rated voltage (II/2)	320 V
Rated surge voltage (II/2)	2.5 kV

Connection data

Connection technology

Nominal cross section	0.5 mm²	
Conductor connection		
Connection method	Push-in spring connection	
Conductor cross-section rigid	0.14 mm² 0.5 mm²	
Conductor cross-section flexible	0.2 mm ² 0.5 mm ² (up to 0.75 mm ² supported, with a stripping length of 7.5 mm and a rated insulation voltage of 32 V at III/2)	
Conductor cross-section AWG	26 20	
Conductor cross-section flexible, with ferrule without plastic 0.25 mm² 0.5 mm² sleeve		
Conductor cross-section, flexible, with ferrule, with plastic sleeve	0.25 mm ² 0.34 mm ² (possible from 0.14 mm ² , when using ferrule AI 0.14- 6 GY in combination with crimping pliers CRIMPFOX 10T-F)	
Cylindrical gauge a x b / diameter	- / 1.2 mm	
Stripping length	6 mm	

Mounting



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Pad geometry

Mounting type	SMD soldering
Pin layout	Linear pad geometry
Processing notes	
Process	Reflow soldering
Moisture Sensitive Level	MSL 1
Classification temperature T _c	260 °C
Solder cycles in the reflow	3
aterial specifications	
Material data - contact	
Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	hot-dip tin-plated
Metal surface terminal point (top layer)	Tin (4 - 8 μm Sn)
Metal surface soldering area (top layer)	Tin (4 - 8 µm Sn)
Material data - housing	
Color (Housing)	signal white (9003)
Insulating material	PA GF
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Material data – actuating element	
Color (Actuating element)	white (9010)
Color (Notability Clerifority	wine (5515)
otes	
Note on application	Pick and place pads may protrude beyond the components. The PCB layout must ensure that collisions are avoided when components are assembled.
mensions	
Dimensional drawing	h
Pitch	2.5 mm
Width [w]	15.1 mm
Height [h]	9 mm
Length [I]	7 mm
PCB design	
Pad geometry	1.4 v 2.4 mm

1.4 x 3.4 mm



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Pin spacing	2.5 mm	
echanical tests		
Connection test		
Specification	IEC 60998-2-2:2002-12	
Result	Test passed	
Foot for conductor damage and claskoning		
Fest for conductor damage and slackening Specification	IEC 60998-2-2:2002-12	
Result	Test passed	
Nesuit	rest passeu	
Pull-out test		
Specification	IEC 60998-2-2:2002-12	
Conductor cross-section/conductor type/tractive force	0.14 mm² / solid / > 10 N	
setpoint/actual value	0.2 mm² / flexible / > 10 N	
	0.5 mm² / solid / > 20 N	
	0.75 mm² / flexible / > 30 N	
Flexion test		
Specification	IEC 60998-2-2:2002-12	
Opcomodion		
Result ectrical tests	Test passed	
Result	IEC 60998-2-1:2002-12	
Result ectrical tests Femperature-rise test		
Result ectrical tests Femperature-rise test Specification Requirement temperature-rise test	IEC 60998-2-1:2002-12	
Result ectrical tests Femperature-rise test Specification Requirement temperature-rise test nsulation resistance	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K	
Result certrical tests Femperature-rise test Specification Requirement temperature-rise test nsulation resistance Specification	IEC 60998-2-1:2002-12	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12	
Result Air clearances and creepage distances	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V	
Result Actrical tests Femperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV 1.5 mm	
Result Actrical tests Femperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV 1.5 mm 1.6 mm	
Result Actrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) minimum creepage distance (III/3) Rated insulation voltage (III/2)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV 1.5 mm 1.6 mm 160 V	
Result Petrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum creepage distance (III/3) Rated insulation voltage (III/2) Rated surge voltage (III/2) Rated surge voltage (III/2)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV 1.5 mm 1.6 mm 160 V 2.5 kV	
Result Cetrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum clearance value - non-homogenous field (III/3) Rated surge voltage (III/2) Rated surge voltage (III/2) Rated surge voltage (III/2) minimum clearance value - non-homogenous field (III/2) minimum clearance value - non-homogenous field (III/2)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV 1.5 mm 1.6 mm 160 V 2.5 kV 1.5 mm	
Result Petrical tests Temperature-rise test Specification Requirement temperature-rise test Insulation resistance Specification Insulation resistance, neighboring positions Air clearances and creepage distances Specification Insulating material group Comparative tracking index (IEC 60112) Rated insulation voltage (III/3) Rated surge voltage (III/3) minimum creepage distance (III/3) Rated insulation voltage (III/2) Rated surge voltage (III/2) Rated surge voltage (III/2)	IEC 60998-2-1:2002-12 Increase in temperature ≤ 45 K IEC 60998-1:2002-12 > 5 MΩ IEC 60664-1:2007-04 I CTI 600 63 V 2.5 kV 1.5 mm 1.6 mm 160 V 2.5 kV	



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minimum clearance value - non-homogenous field (II/2)	1.5 mm
minimum creepage distance (II/2)	1.6 mm

Environmental and real-life conditions

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz 60.1 Hz)
Acceleration	5g (60.1 Hz 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Glow-wire test

Specification	IEC 60998-1:2002-12
Temperature	850 °C
Time of exposure	5 s

Ambient conditions

Ambient temperature (operation)	-40 °C 100 °C (Depending on the current carrying capacity/derating curve)
Ambient temperature (storage/transport)	-40 °C 70 °C
Relative humidity (storage/transport)	30 % 70 %
Ambient temperature (assembly)	-5 °C 100 °C

Packaging specifications

Dimensional drawing	
Type of packaging	44 mm wide tape
[W] tape width	44 mm
[W2] coil overall dimension	≤ 50.4 mm
[A] coil diameter	≤ 330 mm
Outer packaging type	Transparent-Bag

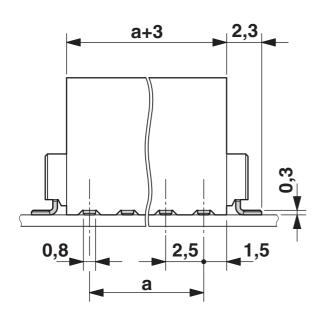


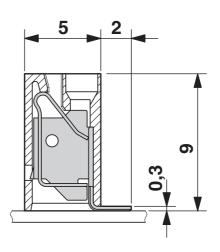
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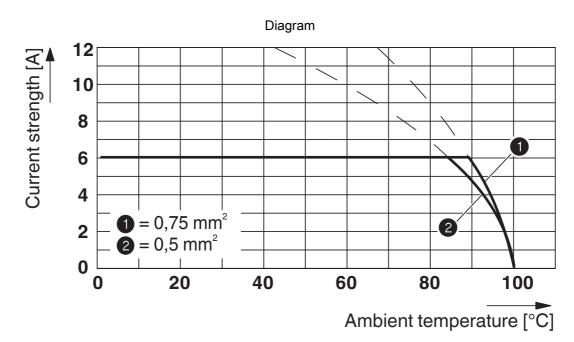
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Drawings

Dimensional drawing







Type: PTSM 0,5/...-2,5-V SMD WH R44
Tested in accordance with DIN EN 60512-5-2:2003-01

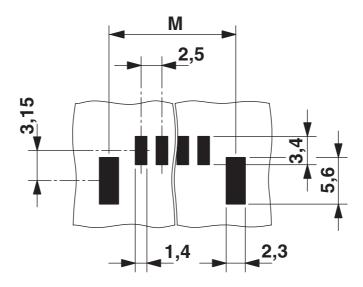
Reduction factor = 1 Number of positions: 5



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Drilling plan/solder pad geometry



Dimension M: 13.4 mm



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Approvals

To download certificates, visit the product detail page: https://www.phoenixcontact.com/us/products/1814728

UL Recognized Approval ID: E118976-20130619					
		Nominal voltage U _N	Nominal current I _N	Cross section AWG	Cross section mm ²
В					
		150 V	5 A	26 - 18	-

c 922 us	cULus Recognized Approval ID: E60425-20030527				
		Nominal voltage U _N	Nominal current I _N	Cross section AWG	Cross section mm ²
В					
		150 V	5 A	26 - 20	-

	VDE Zeichengenehmigung Approval ID: 40048725				
		Nominal voltage U _N	Nominal current I _N	Cross section AWG	Cross section mm ²
keine					
		160 V	6 A	-	0.14 - 0.5



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Classifications

ECLASS

	ECLASS-13.0	27460101		
	ECLASS-15.0	27460101		
ETIM				
	ETIM 9.0	EC002643		
UNSPSC				
	UNSPSC 21.0	39121400		

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Environmental product compliance

25 (6)16				
Fulfills EU RoHS substance requirements	Yes, No exemptions			
China RoHS				
Environment friendly use period (EFUP)	EFUP-E			
	No hazardous substances above the limits			
EU REACH SVHC				
REACH candidate substance (CAS No.)	No substance above 0.1 wt%			

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